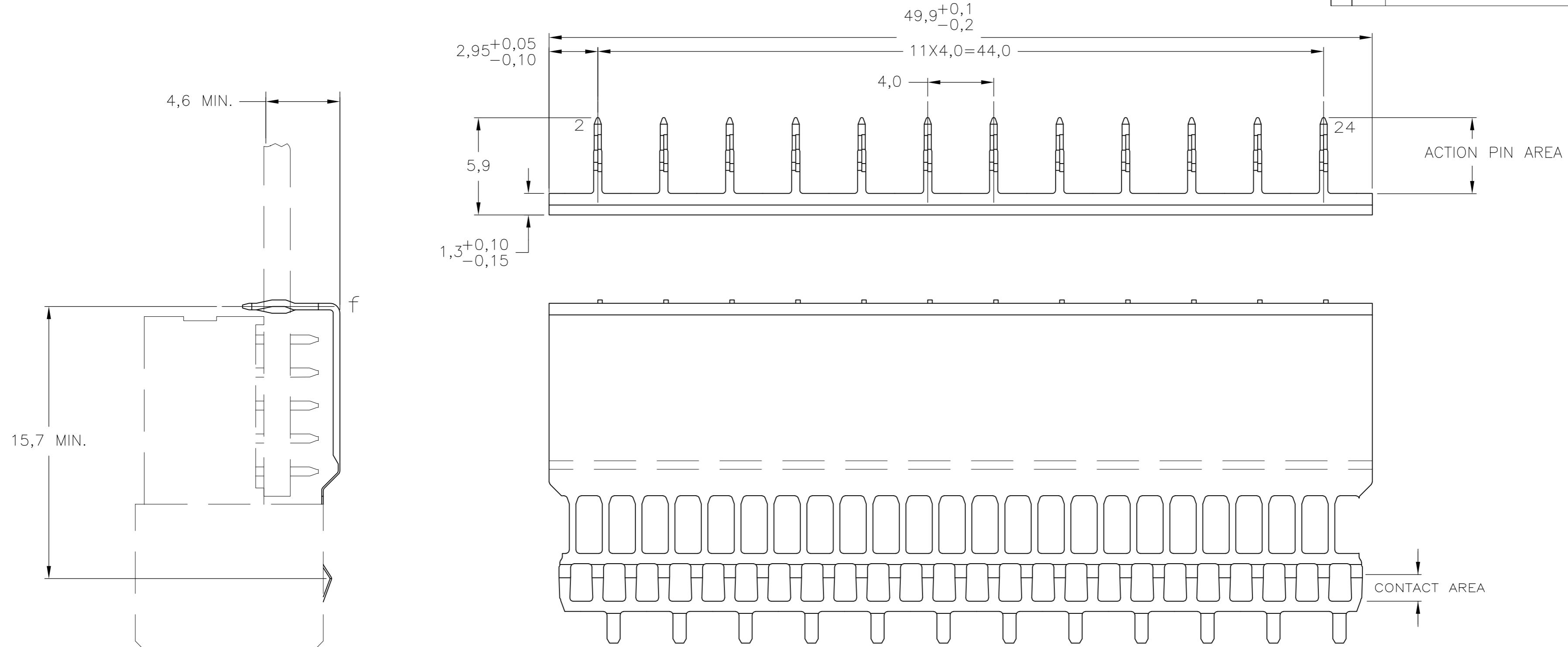


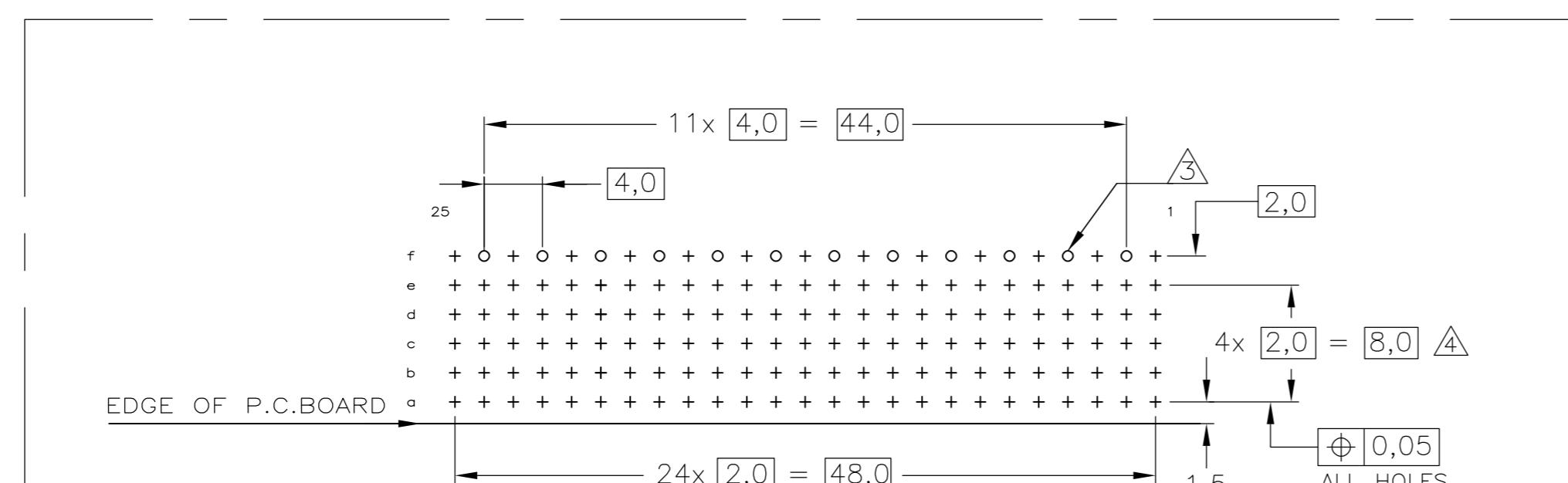
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REVISIONS
 LOC H DIST —
 P LTR D
 DESCRIPTION DATE DWN APVD
 REVISED PER ECO-13-015151 16DEC2013 FL FY



NOTES:

- ▲ GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT): 1,27µm NICKEL MIN. AND ACTION PIN: 0,5µm TIN MIN.
FOR PLATING OF MATING SURFACES SEE PERFORMANCE LEVEL SHOWN IN PART NUMBER TABLE.
- ▲ MATERIAL: PHOSPHORBRONZE.
- ▲ ROW "f" 12 PLATED THROUGH HOLES FOR LOWERSHIELD.
- ▲ HOLE PATTERN FOR FEMALE CONNECTOR TYPE B-25 COLUMNS WITH UPPERSHIELD, 125+13 PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID.
- ▲ MAX. BOARD THICKNESS 3,5 mm.
- ▲ SHIELDS LUBRICATED WITH BELLCORE APPROVED LUBRICANT.
TECHNICAL REF: TR-NWT-001217 ISSUE 1, SEPT. 1992.
- ▲ CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 2.
- ▲ CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 1.
- ▲ CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL III, CENTRAL OFFICE APPLICATIONS.
- ▲ 0.76µm MIN GOLD PLATING AT MATING SURFACE.



COMPONENT SIDE AS SHOWN
 RECOMMENDED PCB-HOLE LAY-OUT

THIS DRAWING IS A CONTROLLED DOCUMENT.

DRAWN BY	K.N.KIRAN	13AUG04
CHK	B.MOOIJ	25MAR05
APVD	B.MOOIJ	25MAR05
PRODUCT SPEC		
	108-19082	APPLICATION SPEC
MATERIAL		114-19029
FINISH		WEIGHT
		-
CAGE CODE	A2 00779	DRAWING NO
	C-5338110	
CUSTOMER DRAWING		SCALE
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